

### SSC8L412GT4

#### **N-Channel Enhancement Mode MOSFET**

#### Features

V <sub>DS</sub>	V <sub>GS</sub>	R <sub>DS(ON)</sub> Typ.	l <sub>D</sub>
40V	+20V	1.4 mΩ@10V	231A
	<u> </u>	2.3 mΩ@4.5V	23 IA

### > Description

This device is N-Channel enhancement MOSFET.

Uses SGT technology and design to provide excellent

RDSON with low gate charge. This device is suitable
for use in DC-DC conversion, power switch and
charging circuit.

100% UIS + ΔVDS + Rg Tested!

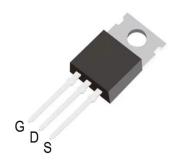
#### Applications

- DC/DC converters
- Power supplies
- Motor Drive Control
- Synchronous rectification

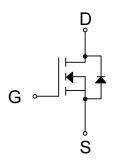
#### Ordering Information

Device	Package	Shipping
SSC8L412GT4	TO-220-3L	50/Tube

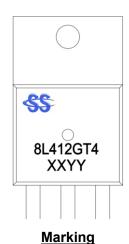
## > Pin Configuration



TO-220-3L (Top View)



**Pin Configuration** 



(XXYY: Internal Traceability Code)



### ➤ Absolute Maximum Ratings (T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit		
$V_{DSS}$	Drain-to-Source Voltage		40	V	
V <sub>GSS</sub>	Gate-to-Source Volta	Gate-to-Source Voltage		V	
	Out the same David Out and I	T <sub>C</sub> =25℃	231	Δ.	
l <sub>D</sub>	Continuous Drain Current <sup>d</sup>	T <sub>C</sub> =100℃	146	A	
	Outline Paris Outline	T <sub>A</sub> =25℃	27	Δ.	
ldsм	Continuous Drain Current <sup>a</sup>	T <sub>A</sub> =70°C	21	Α	
I <sub>DM</sub>	Pulsed Drain Curren	Pulsed Drain Current <sup>b</sup>		Α	
Б	Power Dissipation <sup>c</sup>	Tc=25°C	166	W	
P <sub>D</sub>		T <sub>C</sub> =100℃	66		
Б	Power Dissipation <sup>a</sup>	T <sub>A</sub> =25℃	2.3	10/	
P <sub>DSM</sub>		T <sub>A</sub> =70°C	1.5	W	
las	Avalanche Current <sup>b</sup> L=0.5mH Single Pulse		33	Α	
Eas	Avalanche Energy <sup>b</sup> L=0.5mH Single Pulse		272	mJ	
TJ	Operation junction temperature		-55~150	°C	
T <sub>STG</sub>	Storage temperature range		-55~150		

## ➤ Thermal Resistance Ratings (T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Max.	Unit
RθJA	Junction-to-Ambient Thermal Resistance <sup>a</sup>	55	65	°C/W
R <sub>θJC</sub>	Junction-to-Case Thermal Resistance	0.75	1.0	C/VV

#### Note:

- a. The value of R<sub>θJA</sub> is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz.copper, in a still air environment with T<sub>A</sub>=25°C. The value in any given application depends on the user is specific board design. The power dissipation is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation  $P_D$  is based on  $T_{J(MAX)}$ =150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.

SSC-V1.0 www.sscsemi.com Analog Future



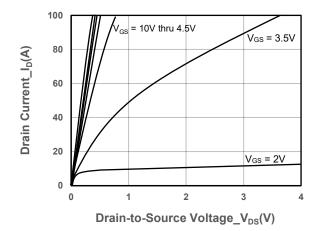


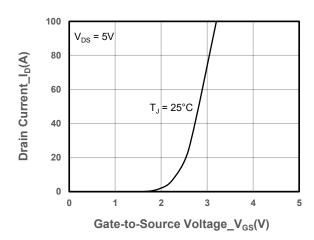
# $\succ$ Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	40			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250uA$	1.0	1.7	2.5	V
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A		1.4	1.9	mΩ
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 10A		2.3	3	mΩ
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 40V, V <sub>GS</sub> = 0V			1	μA
Gate-Source Leak Current	Igss	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V			±100	nA
Transconductance	G <sub>FS</sub>	V <sub>DS</sub> = 5V, I <sub>D</sub> = 15A		40		S
Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = 10A		0.8	1.3	V
Gate Resistance	R <sub>G</sub>	V <sub>DS</sub> = 0V, f = 1MHz		2.4		Ω
Input Capacitance	Cıss	V = 00V V = 0V		3200		
Output Capacitance	Coss	$V_{DS} = 20V, V_{GS} = 0V,$		1876		pF
Reverse Transfer Capacitance	Crss	f = 1MHz		104		
Total Gate Charge	Q <sub>G</sub>	101/1/ 001/		60		
Gate to Source Charge	Q <sub>G</sub> s	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 20V,		18		nC
Gate to Drain Charge	Q <sub>GD</sub>	I <sub>D</sub> = 20A		9		
Turn-on Delay Time	T <sub>D(ON)</sub>			16		
Rise Time	Tr	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 20V,		18		
Turn-off Delay Time	T <sub>D(OFF)</sub>	$I_D = 20A, R_G = 3\Omega$		44		ns
Fall Time	T <sub>f</sub>			12		
Diode Recovery Time	Trr	I <sub>F</sub> =20A, di/dt=100A/us		95		ns
Diode Recovery Charge	Qrr	I <sub>F</sub> =20A, di/dt=100A/us		194		nC

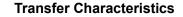


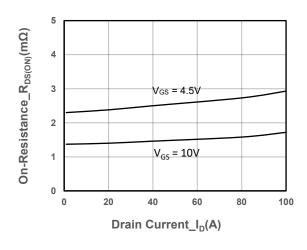
## > Typical Performance Characteristics (T<sub>A</sub>=25℃ unless otherwise noted)

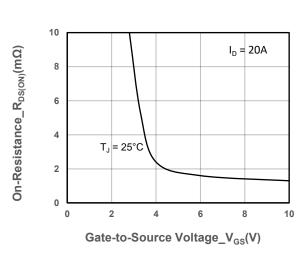




#### **Output Characteristics**

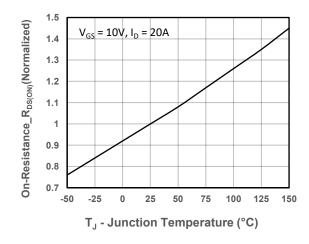


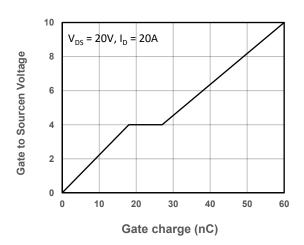




#### On-Resistance vs. Drain Current and Gate Voltage

On-Resistance vs. Gate-to-Source Voltage

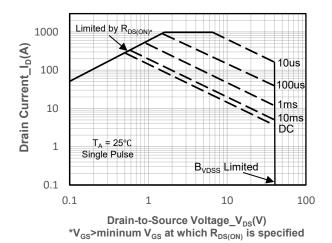




On-Resistance vs. Junction Temperature

Gate-Source Voltage vs. Gate charge

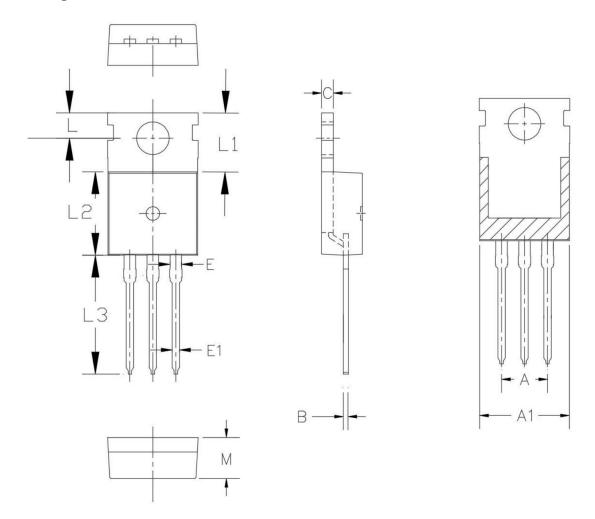




Safe Operating Area vs. Junction-to-Ambient



# Package Information



Symbol	MILL IMETER			
Symbol	Min	Nom	Max	
Α		5.08 BSC		
A1	9.00	10.00	11.00	
В	0.33		0.65	
С	1.20		1.40	
E	1.17		1.37	
E1	0.60		1.10	
L	2.50		3.00	
L1	6.3	6.5	6.7	
L2	8.95		9.75	
L3	12.88		13.40	
M	4.30		4.70	



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